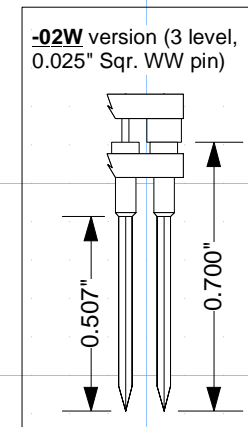
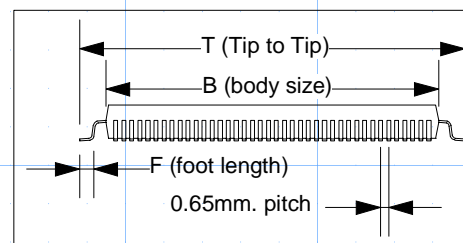


	T (in mm.)	B (in mm.)	F (in mm.)
PA-QFE100RA-C-Z-02	19.6X25.6	14.0X20.0	1.7
PA-QFE100RB-C-Z-02	17.2X23.2	14.0X20.0	0.8
PA-QFE100RC-C-Z-02	17.9X23.9	14.0X20.0	0.8
PA-QFE100RD-C-Z-02	17.2X23.2	14.0X20.0	0.58



- 1 Substrate: 0.0625"±0.007" FR4/G10 or equivalent high temp material. 1/2 oz. Cu clad. SnPb plating
- 2 Pins: Material- Brass Alloy 360 1/2 hard; finish- 10µ" Au over 50µ" Ni (min.).
- 6 Stand-off: material- Teflon; 0.085" Dia; 0.060" thick.

Description: PROTOTYPING ADAPTOR

100 position QFP ZIF socket to Type C base pin array. Add "W" to part number for optional wire wrap sub base.

PA-QFE100R(A,B,C,D)-C-Z-02(W) Drawing



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 Tele: (651) 452-8100
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Status: Released

Scale: 1:0.6

Rev: E

Drawing: C Hautman

Date: 1/24/94

File: PA-QFE100RA-C-Z-02 Dwg

Modified: 7/31/98

All tolerances: ±0.005" (unless stated otherwise). Materials and specifications are subject to change without notice.